mail

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





NDS8926 Dual N-Channel Enhancement Mode Field Effect Transistor

General Description

Features

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance and provide superior switching performance. These devices are particularly suited for low voltage applications such as DC motor control and DC/DC conversion where fast switching, low in-line power loss, and resistance to transients are needed.

- High density cell design for extremely low R_{DS(ON)}.
- High power and current handling capability in a widely used surface mount package.
- Dual MOSFET in surface mount package.





Absolute Maximum Ratings $T_A = 25^{\circ}C$ unless otherwise note

Symbol	Parameter		NDS8926	Units
V _{DSS}	Drain-Source Voltage		20	V
V _{GSS}	Gate-Source Voltage		8	V
I _D	Drain Current - Continuous	(Note 1a)	5.5	А
	- Pulsed		20	
P _D	Power Dissipation for Dual Operation		2	W
	Power Dissipation for Single Operation	(Note 1a)	1.6	
		(Note1b)	1	
		(Note1c)	0.9	
T _J ,T _{STG}	Operating and Storage Temperature Range	e	-55 to 150	°C
THERMA	L CHARACTERISTICS			
R _{θJA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	78	°C/W
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	40	°C/W

©1997 Fairchild Semiconductor Corporation

July 1996

ELECTRICAL CHARACTERISTICS (T _A = 25°C unless otherwise noted)											
Symbol	Parameter	Conditions		Min	Тур	Max	Units				
OFF CHAR	ACTERISTICS										
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$		20			V				
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 16 \text{ V}, V_{GS} = 0 \text{ V}$				1	μA				
			T _J = 55°C			10	μA				
	Gate - Body Leakage, Forward	$V_{GS} = 8 V, V_{DS} = 0 V$				100	nA				
	Gate - Body Leakage, Reverse	$V_{GS} = -8 V, V_{DS} = 0 V$				-100	nA				
ON CHARA	CTERISTICS (Note 2)										
V _{GS(th)}	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = 250 \mu\text{A}$		0.4	0.6	1	V				
			T _J = 125°C	0.3	0.35	0.8					
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = 4.5 \text{ V}, I_{D} = 5.5 \text{ A}$			0.029	0.035	Ω				
			T _J = 125°C		0.04	0.063					
		$V_{GS} = 2.7 \text{ V}, I_{D} = 5 \text{ A}$			0.035	0.045					
I _{D(on)}	On-State Drain Current	$V_{GS} = 4.5 \text{ V}, V_{DS} = 5 \text{ V}$		20			А				
		$V_{GS} = 2.7 \text{ V}, V_{DS} = 5 \text{ V}$		10							
g _{fs}	Forward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 5.5 \text{ A}$			14		S				
DYNAMIC (CHARACTERISTICS										
C _{iss}	Input Capacitance	$V_{DS} = 10 V, V_{GS} = 0 V,$			760		pF				
C _{oss}	Output Capacitance	t = 1.0 MHz	f = 1.0 MHz		440		pF				
C _{rss}	Reverse Transfer Capacitance				160		pF				
SWITCHING	CHARACTERISTICS (Note 2)				-						
t _{D(on)}	Turn - On Delay Time	$V_{DD} = 6 V, I_{D} = 1 A,$	$V_{DD} = 6 V, I_D = 1 A,$		10	20	ns				
t,	Turn - On Rise Time	$V_{GS} = 4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$			30	50	ns				
t _{D(off)}	Turn - Off Delay Time				55	80	ns				
t _r	Turn - Off Fall Time				20	40	ns				
Q _g	Total Gate Charge	$V_{DS} = 10 V,$			21	30	nC				
Q_{gs}	Gate-Source Charge	$I_{\rm D} = 5.5 \text{A}, V_{\rm GS} = 4.5 \text{V}$			2.3		nC				
Q_{gd}	Gate-Drain Charge				6.8		nC				





NDS8926 Rev. D2



